

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Shigeki Satou et al.
Application No. : 10/582,995
Filed : June 14, 2006
For : DIELECTRIC PASTE FOR SPACER LAYER OF A MULTI-
LAYERED CERAMIC ELECTRONIC COMPONENT
Examiner : Tabassom Tadayyon Eslami
Art Unit : 1792
Docket No. : 890050.541USPC
Date : March 30, 2009

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT TRANSMITTAL

Commissioner for Patents:

In accordance with 37 CFR 1.56 and 1.97 through 1.98, applicants wish to make known to the U.S. Patent and Trademark Office the references set forth on the attached Information Disclosure Statement.

Applicants' Representative wishes to thank the Examiner for the phone call of March 27, 2009, in which the Examiner indicated that the present application is in condition for allowance. As discussed during this phone call, an Information Disclosure Statement was at that time being prepared to disclose a reference that was cited less than three months ago in a Chinese Patent Office Action dated on January 9, 2009 in a related foreign application. We have also reviewed pending U.S. applications 10/590,538 and 10/590,683 which are by the same inventors in a similar subject matter field but have a different claim scope. These other two applications have been allowed and applicants submit herewith the references that are in the record of those cases in the attached Information Disclosure Statement. Applicants thank the Examiner in advance for consideration of these references.

Copies of cited U.S. patents and published patent applications are not required and accordingly have not been provided. Copies of any other cited references are enclosed. As to any reference cited, applicants do not admit that it is “prior art” under 35 U.S.C. §§ 102 or 103, and specifically reserve the right to traverse or antedate any such reference, as by a showing under 37 CFR 1.131 or other method. Although the aforesaid references are made known to the Patent and Trademark Office in compliance with applicants’ duty to disclose all information they are aware of which is believed relevant to the examination of the above-identified application, applicants believe that their invention is patentable.

Please acknowledge receipt of this Information Disclosure Statement and kindly make the cited references of record in the above-identified application.

A fee of \$180 is submitted in accordance with 37 CFR 1.97(c). The Director is authorized to charge any other fees which may be required, or credit any overpayment to Deposit Account No. 19-1090.

Respectfully submitted,

SEED Intellectual Property Law Group PLLC

/Nima A. Seyedali/

Nima A. Seyedali

Registration No. 61,293

NAS:jrh

Enclosures:

Information Disclosure Statement
Cited References (9)

701 Fifth Avenue, Suite 5400
Seattle, Washington 98104
Phone: (206) 622-4900
Fax: (206) 682-6031

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